

FEATURES

- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 10 μ A (Max.) @ $V_{DS} = 60V$
- Lower $R_{DS(ON)}$: 0.122 Ω (Typ.)

$BV_{DSS} = 60 V$
 $R_{DS(on)} = 0.155 \Omega$
 $I_D = 8.2 A$



1. Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	60	V
I_D	Continuous Drain Current ($T_c=25^\circ C$)	8.2	A
	Continuous Drain Current ($T_c=100^\circ C$)	5.2	
I_{DM}	Drain Current-Pulsed ①	30	A
V_{GS}	Gate-to-Source Voltage	± 0	V
E_{AS}	Single Pulsed Avalanche Energy ②	58	mJ
I_{AR}	Avalanche Current ①	8.2	A
E_{AR}	Repetitive Avalanche Energy ①	1.8	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.5	V/ns
P_D	Total Power Dissipation ($T_A=25^\circ C$) *	2.5	W
	Total Power Dissipation ($T_c=25^\circ C$)	18	W
	Linear Derating Factor	0.14	$W/W^\circ C$
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ C$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	6.81	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient *	—	50	
$R_{\theta JA}$	Junction-to-Ambient	—	110	

* When mounted on the minimum pad size recommended (PCB Mount).

ELECTRONICS

IRLR/U014A

N-CHANNEL
POWER MOSFET

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	60	—	—	V	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\text{ }\mu\text{A}$
$\Delta \text{BV}/\Delta T_J$	Breakdown Voltage Temp. Coeff.	—	0.045	—	V°C	$\text{I}_D=250\text{ }\mu\text{A}$ See Fig 7
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	1.0	—	2.0	V	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=250\text{ }\mu\text{A}$
I_{GSS}	Gate-Source Leakage, Forward	—	—	100	nA	$\text{V}_{\text{GS}}=20\text{V}$
	Gate-Source Leakage, Reverse	—	—	-100		$\text{V}_{\text{GS}}=-20\text{V}$
$\text{I}_{\text{DS}}^{\text{SS}}$	Drain-to-Source Leakage Current	—	—	10	μA	$\text{V}_{\text{DS}}=60\text{V}$
		—	—	100		$\text{V}_{\text{DS}}=48\text{V}, \text{T}_c=125^\circ\text{C}$
$\text{R}_{\text{DS(on)}}$	Static Drain-Source On-State Resistance	—	—	0.155	Ω	$\text{V}_{\text{GS}}=5\text{V}, \text{I}_D=4.1\text{A}$ ④
g_{fs}	Forward Transconductance	—	4.9	—	mS	$\text{V}_{\text{DS}}=30\text{V}, \text{I}_D=4.1\text{A}$ ④
C_{iss}	Input Capacitance	—	265	345	pF	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=25\text{V}, f=1\text{MHz}$ See Fig 5
C_{oss}	Output Capacitance	—	100	115		
C_{rss}	Reverse Transfer Capacitance	—	37	45		
$t_{\text{d(on)}}$	Turn-On Delay Time	—	10	30	ns	$\text{V}_{\text{DD}}=30\text{V}, \text{I}_D=10\text{A}, \text{R}_G=12\Omega$ See Fig 13 ④ ⑤
t_r	Rise Time	—	16	45		
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	21	55		
t_f	Fall Time	—	15	40		
Q_g	Total Gate Charge	—	7.2	10	nC	$\text{V}_{\text{DS}}=48\text{V}, \text{V}_{\text{GS}}=5\text{V}, \text{I}_D=10\text{A}$ See Fig 6 & Fig 12 ④ ⑤
Q_{gs}	Gate-Source Charge	—	2.6	—		
Q_{gd}	Gate-Drain("Miller") Charge	—	3.2	—		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_s	Continuous Source Current	—	—	8.2	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	—	—	30		
V_{SD}	Diode Forward Voltage ④	—	—	1.5	V	$\text{T}_J=25^\circ\text{C}, \text{I}_s=8.2\text{A}, \text{V}_{\text{GS}}=0\text{V}$
t_{rr}	Reverse Recovery Time	—	50	—	ns	$\text{T}_J=25^\circ\text{C}, \text{I}_f=10\text{A}$ $d\text{I}_f/dt=100\text{A}/\mu\text{s}$ ④
Q_{rr}	Reverse Recovery Charge	—	0.075	—		

Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=1\text{mH}, \text{I}_{\text{AS}}=8.2\text{A}, \text{V}_{\text{DD}}=25\text{V}, \text{R}_G=27\Omega$, Starting $\text{T}_J=25^\circ\text{C}$
- ③ $\text{I}_{\text{sd}} \leq 10\text{A}, d\text{I}/dt \leq 200\text{A}/\mu\text{s}, \text{V}_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, Starting $\text{T}_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width = 250 μs , Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

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Fig 1. Output Characteristics

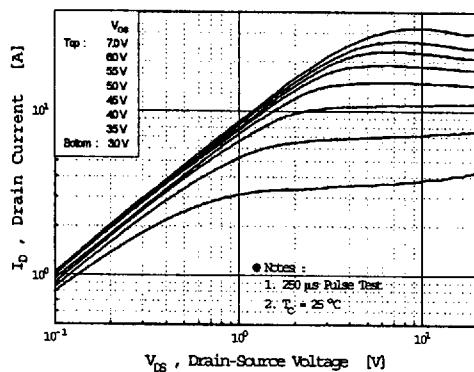


Fig 2. Transfer Characteristics

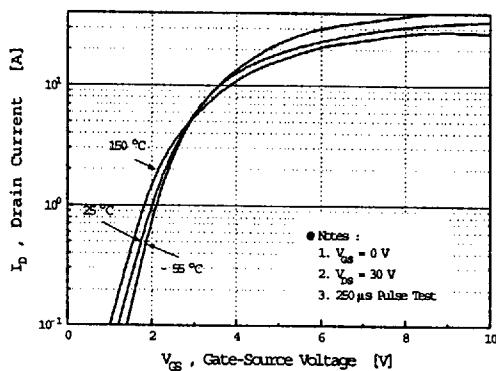


Fig 3. On-Resistance vs. Drain Current

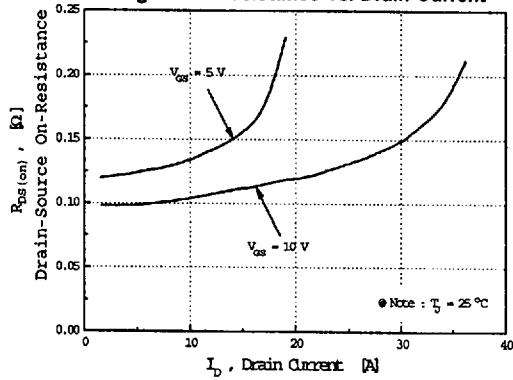


Fig 4. Source-Drain Diode Forward Voltage

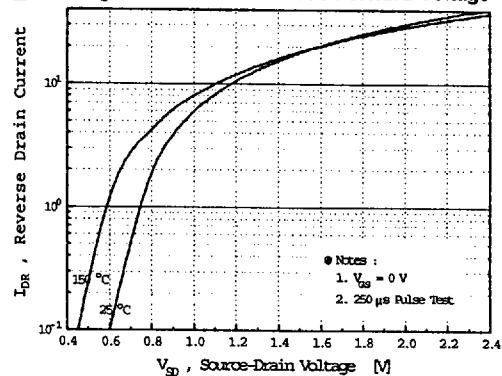


Fig 5. Capacitance vs. Drain-Source Voltage

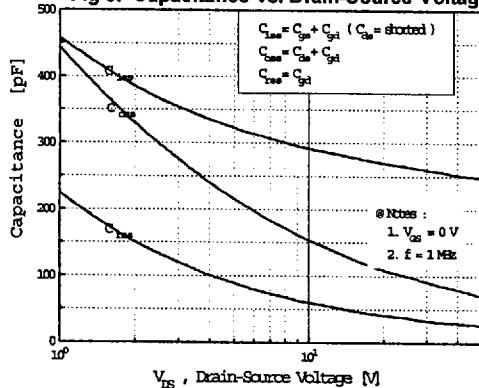
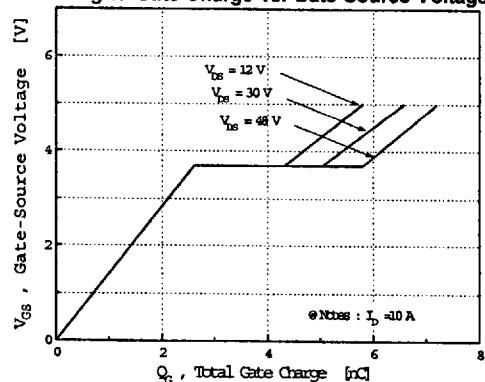


Fig 6. Gate Charge vs. Gate-Source Voltage



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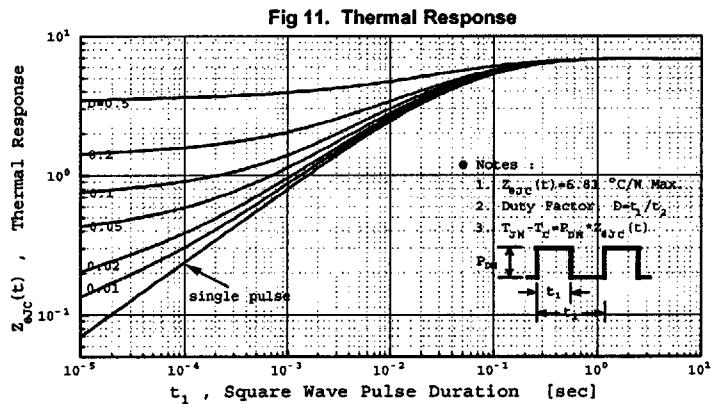
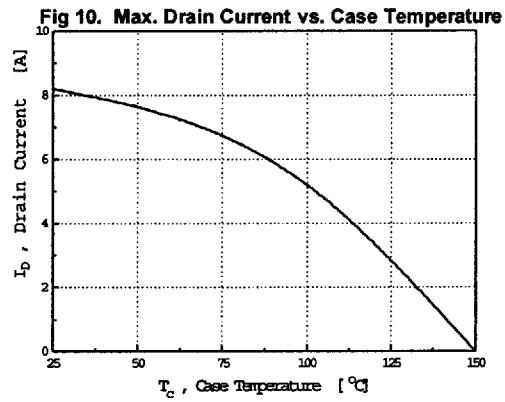
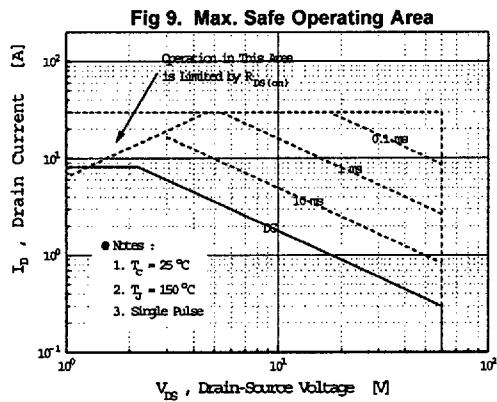
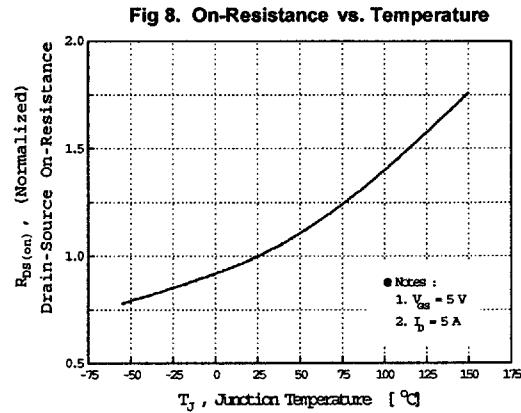
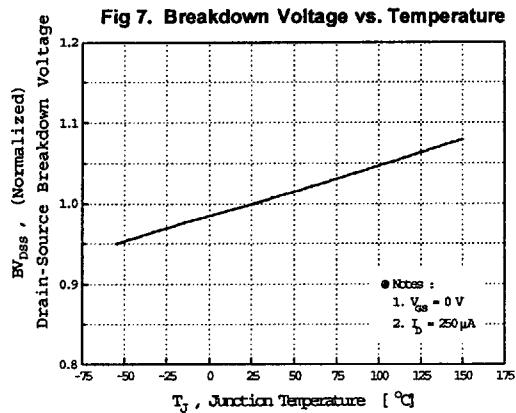


Fig 12. Gate Charge Test Circuit & Waveform

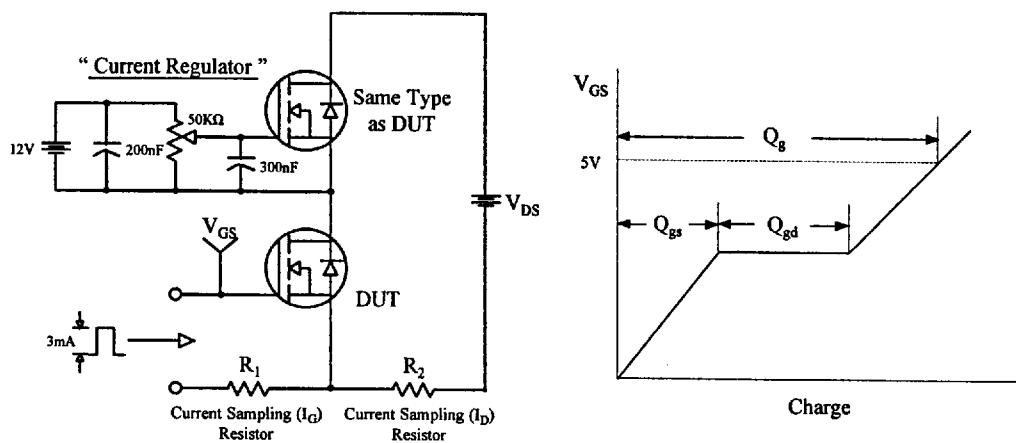


Fig 13. Resistive Switching Test Circuit & Waveforms

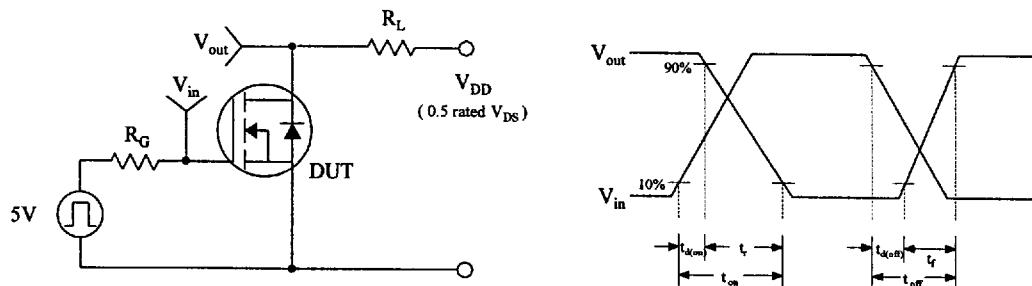


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

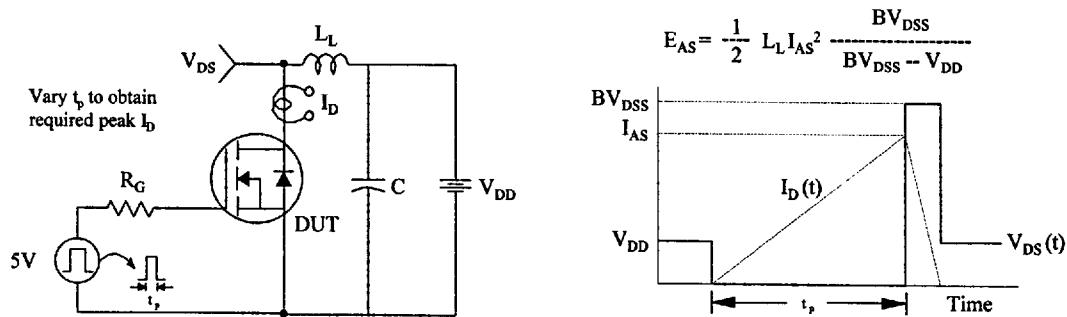


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

